Product data sheet

1. Product profile

1.1 General description

The BB171 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

1.2 Features and benefits

- Excellent linearity
- Very small SMD plastic package
- $C_{d(28V)} = 2.7 \text{ pF}$; $C_{d(1V)}$ to $C_{d(28V)}$ ratio = 22
- Low series resistance

1.3 Applications

■ Voltage Controlled Oscillators (VCO)

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	11
2	anode	1 2	sym008

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB171	SC-76	plastic surface-mounted package; 2 leads	SOD323



VHF variable capacitance diode

4. Marking

Table 3. Marking

Type number	Marking code
BB171	4J

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	32	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
I _F	forward current		-	20	mΑ
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5. Characteristics

 $T_i = 25$ °C unless otherwise specified.

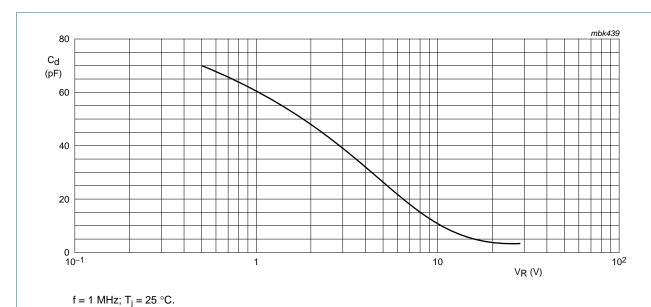
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _R	reverse current	$V_R = 30 \text{ V}$	[1]	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nΑ
r _s	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$		-	1	1.2	Ω
C _d	diode capacitance	f = 1 MHz	[2]				
		V _R = 1 V		52	-	62	pF
		V _R = 28 V		2.48	2.7	2.89	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.31	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		20.6	22	-	
C _{d(25V)} /C _{d(28V)}	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.05	-	

^[1] See Figure 2.

[2] See Figure 1 and Figure 3.

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Diode capacitance as a function of reverse voltage; typical values.

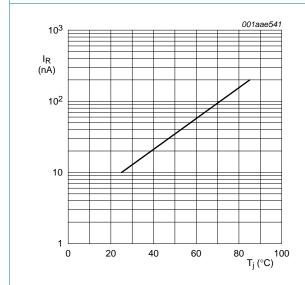


Fig 2. Reverse current as a function of junction temperature; maximum values.

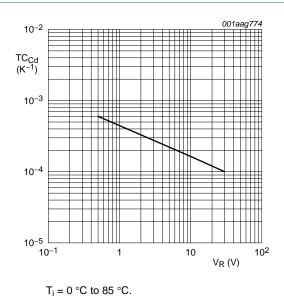


Fig 3. Diode capacitance temperature coefficient as a function of reverse voltage; typical values.

Fig 1.

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7. Package outline

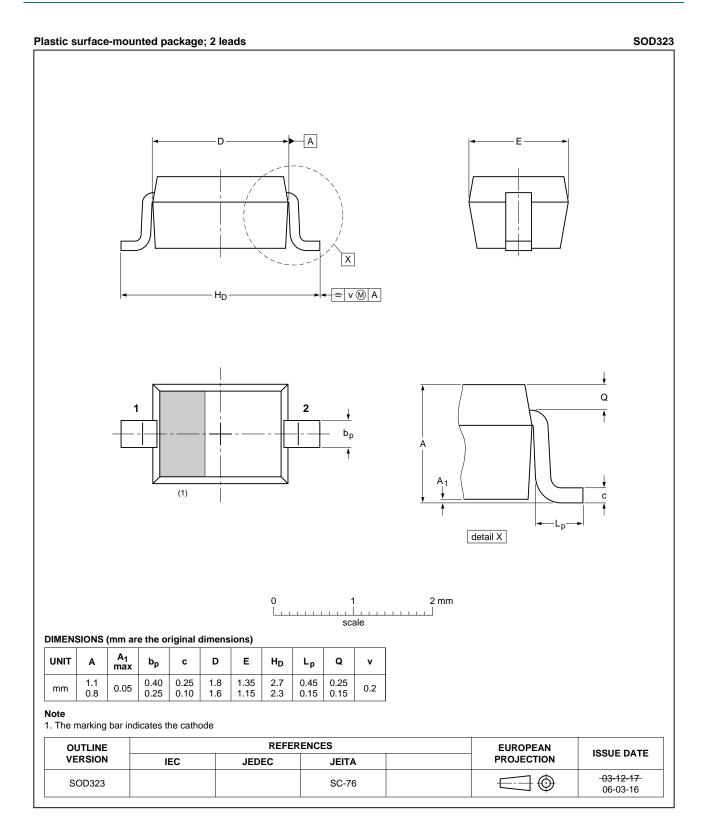


Fig 4. Package outline SOD323 (SC-76)

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VHF variable capacitance diode

8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB171 v.1	20130325	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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